

Dual N-Channel MOSFET

General Description

The WSP9936 is the highest performance trench N-ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WSP9936 meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

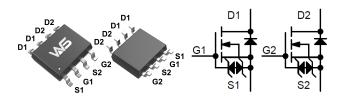
Product Summery

BVDSS	RDSON	ID
20V	14mΩ	8A

Applications

- High Frequency Point-of-Load Synchronous
 Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- ESD:2KV

SOP-8 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	20	V	
V_{GS}	Gate-Source Voltage	±12	V	
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	8	Α	
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 4.5V ¹	6.1	А	
I _{DM}	Pulsed Drain Current ² 40		Α	
P _D @T _A =25°C	Total Power Dissipation ³ 2		W	
T _{STG}	Storage Temperature Range -55 to 150		$^{\circ}$	
TJ	Operating Junction Temperature Range -55 to 150		$^{\circ}$	

Thermal Data

Symbol	Parameter Typ.		Max.	Unit	
$R_{ heta JA}$	Thermal Resistance Junction-ambient ¹		62.5	°C/W	
R _{eJC}	Thermal Resistance Junction-Case ¹		10	°C/W	



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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.022		V/°C
	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =8A		15	26	mΩ
R _{DS(ON)}		V _{GS} =2.5V , I _D =6.8A		19	34	
$V_{GS(th)}$	Gate Threshold Voltage	\/ -\/ -250A	0.5	0.75	1.1	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	V _{GS} =V _{DS} , I _D =250uA		-2.33		mV/℃
I _{DSS}	Drain Source Leakage Current	V _{DS} =16V , V _{GS} =0V , T _J =25℃			1	
	Drain-Source Leakage Current	V _{DS} =16V , V _{GS} =0V , T _J =55°C			5	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm12V$, V_{DS} = $0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =5A		25		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		4.5		Ω
Q_g	Total Gate Charge (4.5V)	V _{DS} =10V , V _{GS} =4.5V , I _D =8A		15.6	17	
Q_gs	Gate-Source Charge			1.3		nC
Q _{gd}	Gate-Drain Charge			2.5		
T _{d(on)}	Turn-On Delay Time			4	9.5	
T _r	Rise Time	V_{DD} =10V , V_{GS} =4.5V , R_{G} =6 Ω		6	24	ns
T _{d(off)}	Turn-Off Delay Time	$I_D=5A$, $R_L=10\Omega$.		25	73	
T _f	Fall Time			4	39	
Ciss	Input Capacitance	V _{DS} =10V , V _{GS} =0V , f=1MHz		520		
C _{oss}	Output Capacitance			105		pF
C _{rss}	Reverse Transfer Capacitance			60		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,4}	// =// =0\/ Force Current			3.7	Α
I _{SM}	Pulsed Source Current ^{2,4}	V _G =V _D =0V , Force Current			40	Α
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1.3	V
t _{rr}	Reverse Recovery Time			19.2		nS
Q _{rr}	Reverse Recovery Charge	lF=8A,dI/dt=100A/μs,T _J =25℃		4.6		nC

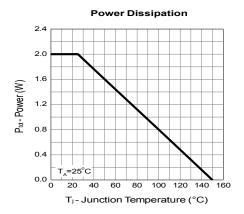
Note:

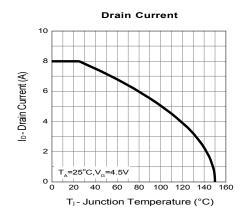
^{1.} The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

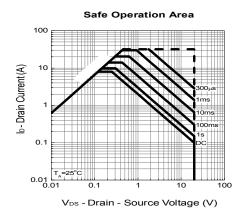
^{4.} The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

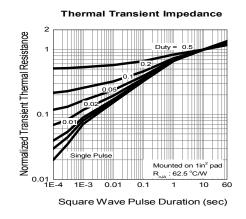


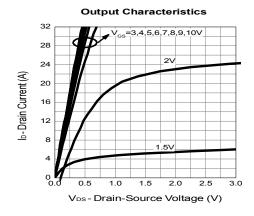
Typical Characteristics

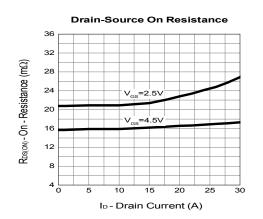






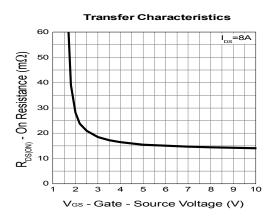


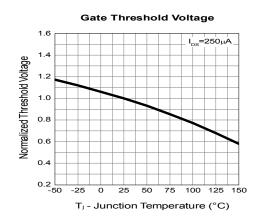


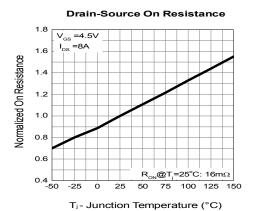


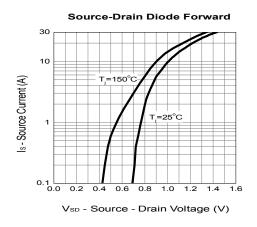


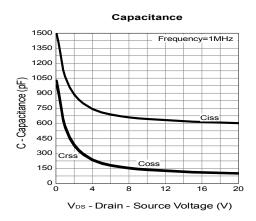


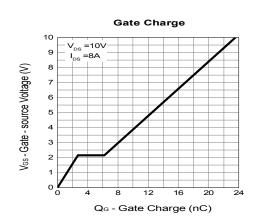














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